Application Data Sheet

Application Information Application number:: Filing Date:: Regular Application Type:: Subject Matter:: Utility Suggested classification:: Suggested Group Art Unit:: CD-ROM or CD-R??:: Number of CD disks:: Number of copies of CDs:: Sequence Submission:: Computer Readable Form (CRF)?:: Number of copies of CRF:: A METHOD AND STRUCTURE FOR LAYOUT OF Title:: CELL CONTACT AREA FOR SEMICONDUCTOR INTEGRATED CIRCUITS 021653-003500US Attorney Docket Number:: Request for Early Publication:: No Request for Non-Publication:: No Suggested Drawing Figure:: 4 **Total Drawing Sheets::** Small Entity?:: No Latin name:: Variety denomination name:: Petition included?:: No Petition Type:: Licensed US Govt. Agency::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.:: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Republic of China

Status:: Full Capacity

Given Name:: Chia Te

Middle Name::

Family Name:: Wu

Name Suffix::

City of Residence:: Shanghai

State or Province of Residence::

Country of Residence:: Peoples Republic of China

Street of Mailing Address:: 18 Zhang Jiang Rd.

Postal Address Line Two:: Pudong New Area

City of Mailing Address:: Shanghai

State or Province of mailing address::

Country of mailing address:: Peoples Republic of China

Postal or Zip Code of mailing address:: 201203

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Peoples Republic of China

Status:: Full Capacity

Given Name:: Jian-Xiang

Middle Name::.

Family Name:: Cai

Name Suffix::

City of Residence:: Shanghai

State or Province of Residence::

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Street of Mailing Address:: 18 Zhang Jiang Rd.

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Postal Address Line Two::

Pudong New Area

City of Mailing Address::

Shanghai

State or Province of mailing address::

Country of mailing address::

Peoples Republic of China

Postal or Zip Code of mailing address:: 201203

Correspondence Information

Correspondence Customer Number::

20350

Representative Information

Representative Customer Number::

20350

Domestic Priority Information

Application::

Continuity Type::

Parent Application:: Parent Filing Date::

Foreign Priority Information

Country::

Application number::

Filing Date::

People's Republic of China

200310122971.5

12/30/03

Assignee Information

Assignee Name: Semiconductor Manufacturing International (Shanghai) Corporation

Street of mailing address:: 18 Zhang Jiang Road, Pudong New Area

City of mailing address::

Shanghai

Country of mailing address::

People's Republic of China

Postal or Zip Code of mailing address:: 201203

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